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FORM PTO-1083

IN THE MITTED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Yasuo Okada

Serial No: 10/619,934 Filed: July 15, 2003

For: MANUFACTURING METHOD OF SEMICONDUCTOR

DEVICE AND SEMICONDUCTOR DEVICE

Mail Stop Non-Fee Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 Art Unit: 2823
Confirmation No.: 6832
Examiner: Hsien-Ming Lee

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Mail Stop Non-Fee Amendment, Commissioner for Patents P.O. Box 1450, Alexandria, VA 22313-1450,

June 14, 2004

Date of Deposit

W illiam H. Wright, Reg. No. 36,312

Signature Date

Dear Sir:

Transmitted herewith is an amendment in the above-identified application.

Annotated Sheets of Drawings Showing changes to FIGS. 1-3 and replacement sheets enclosed.

No additional fee is required.

The fee has been calculated as shown below:

	(Col. 1) CLAIMS REMAINING AFTER AMENDMENT		(Col. 2) HIGHEST NUMBER PREVIOUSLY PAID FOR		(Col. 3) PRESENT EXTRA*	LG/SM \$ ENTITY FEE		ADD'L FEE DUE	
TOTAL CLAIMS FEE	16	-	20	**	0	LG=\$18 SM=\$9	\$18	\$	0
INDEPENDENT CLAIMS FEE	3	-	3	***	0	LG=\$86 SM=\$43	\$86	\$	0
FIRST PRESENTATION OF MULTIPLE DEPENDENT CLAIMS LARGE ENTITY FEE = \$290 SMALL ENTITY FEE = \$145								\$	
						· · · · · · · · · · · · · · · · · · ·	TOTAL	\$	0

* If the entry in Col. 1 is less than the entry in Col. 2, write "0" in Col. 3.

** If the "Highest Number Previously Paid For" IN THIS SPACE is less than 20, write "20" in this space.

*** If the "Highest Number Previously Paid For" IN THIS SPACE is less than 3, write "3" in this space. The "Highest Number Previously Paid For" (Total or Independent) is the highest number found from the equivalent box on Col. 1 of a prior amendment or the number of claims originally filed.

A check in the amount of \$ 0 to cover the additional claims fee is enclosed. A copy of this sheet is enclosed.

A check in the amount of \$____0 to cover the extension fee is enclosed. A copy of this sheet is enclosed.

The Commissioner is hereby authorized to charge any deficiencies of fees associated with this communication or credit any overpayment to Deposit Account No. 50-1314. A copy of this sheet is enclosed.

Any filing fees under 37 C.F.R. § 1.16 for the presentation of extra claims

Any patent application processing fees under 37 C.F.R. § 1.17

Date: June 14, 2004

Biltmore Tower 500 South Grand Avenue, Suite 1900 Los Angeles, California 90071 Telephone: 213 337-6700

Facsimile: 213 337-6701

Respectfully submitted, HOGAN & HARTSON L.L.P

William H. Wright

Registration No. 36,342 Attorney for Applicant(s) Appl. No. 10/619,934 Amdt. Pated June 14, 2004

Reply to Office Action of March 22, 2004

Attorney Docket No. 81788.0253 Customer No.: 26021

Art Unit: 2823

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Yasuo Okada

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MANUFACTURING METHOD OF

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SEMICONDUCTOR DEVICE

AMENDMENT

Mail Stop No Fee Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action dated March 22, 2004, please amend the above-referenced application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Amendments to the Drawings begin on page 6 of this paper and include both an attached replacement sheet and an annotated sheet showing changes.

Remarks/Arguments begin on page 7 of this paper.

An **Appendix** including amended drawing figures is attached following the last page of this paper.

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Alexandria, VA 22313-1450
June 14 2004
Date of Deposit

William H. Wright, Reg. No. 36,312

Name

6/14/04
Signature

Date

Examiner: Hsien-Ming Lee